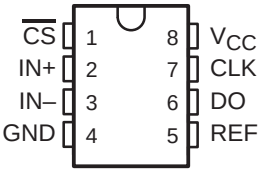
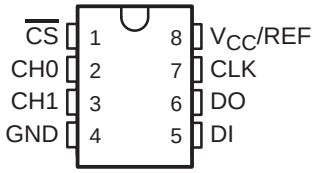
SLAS006 – AUGUST 1985 – REVISED JUNE 1986

- **8-Bit Resolution**
- **Easy Microprocessor interface or Stand-Alone Operation**
- **Operates Ratiometrically or With 5-V Reference**
- **Single Channel or Multiplexed Twin Channels With Single-Ended or Differential Input Options**
- **Input Range 0 to 5 V With Single 5-V Supply**
- **Inputs and Outputs Are Compatible With TTL and MOS**
- **Conversion Time of 32 μs at CLK = 250 kHz**
- **Designed to Be interchangeable With National Semiconductor ADC0831 and ADC0832**

ADC0831 . . . P PACKAGE
(TOP VIEW)



ADC0832 . . . P PACKAGE
(TOP VIEW)



DEVICE	TOTAL UNADJUSTED ERROR	
	A-SUFFIX	B-SUFFIX
ADC0831	± 1 LSB	± 1/2 LSB
ADC0832	± 1 LSB	± 1/2 LSB

description

These devices are 8-bit successive-approximation analog-to-digital converters. The ADC0831A and ADC0831B have single input channels; the ADC0832A and ADC0832B have multiplexed twin input channels. The serial output is configured to interface with standard shift registers or microprocessors. Detailed information on interfacing to most popular microprocessors is readily available from the factory.

The ADC0832 multiplexer is software configured for single-ended or differential inputs. The differential analog voltage input allows for common-mode rejection or offset of the analog zero input voltage value. In addition, the voltage reference input can be adjusted to allow encoding any smaller analog voltage span to the full 8 bits of resolution.

The operation of the ADC0831 and ADC0832 devices is very similar to the more complex ADC0834 and ADC0838 devices. Ratiometric conversion can be attained by setting the REF input equal to the maximum analog input signal value, which gives the highest possible conversion resolution. Typically, REF is set equal to V_{CC} (done internally on the ADC0832). For more detail on the operation of the ADC0831 and ADC0832 devices, refer to the ADC0834/A DC0838 data sheet.

The ADC0831AC, ADC0831BC, ADC0832AC, and ADC0832BC are characterized for operation from 0°C to 70°C. The ADC0831AI, ADC0831BI, ADC0832AI, and ADC0832BI are characterized for operation from –40°C to 85°C.

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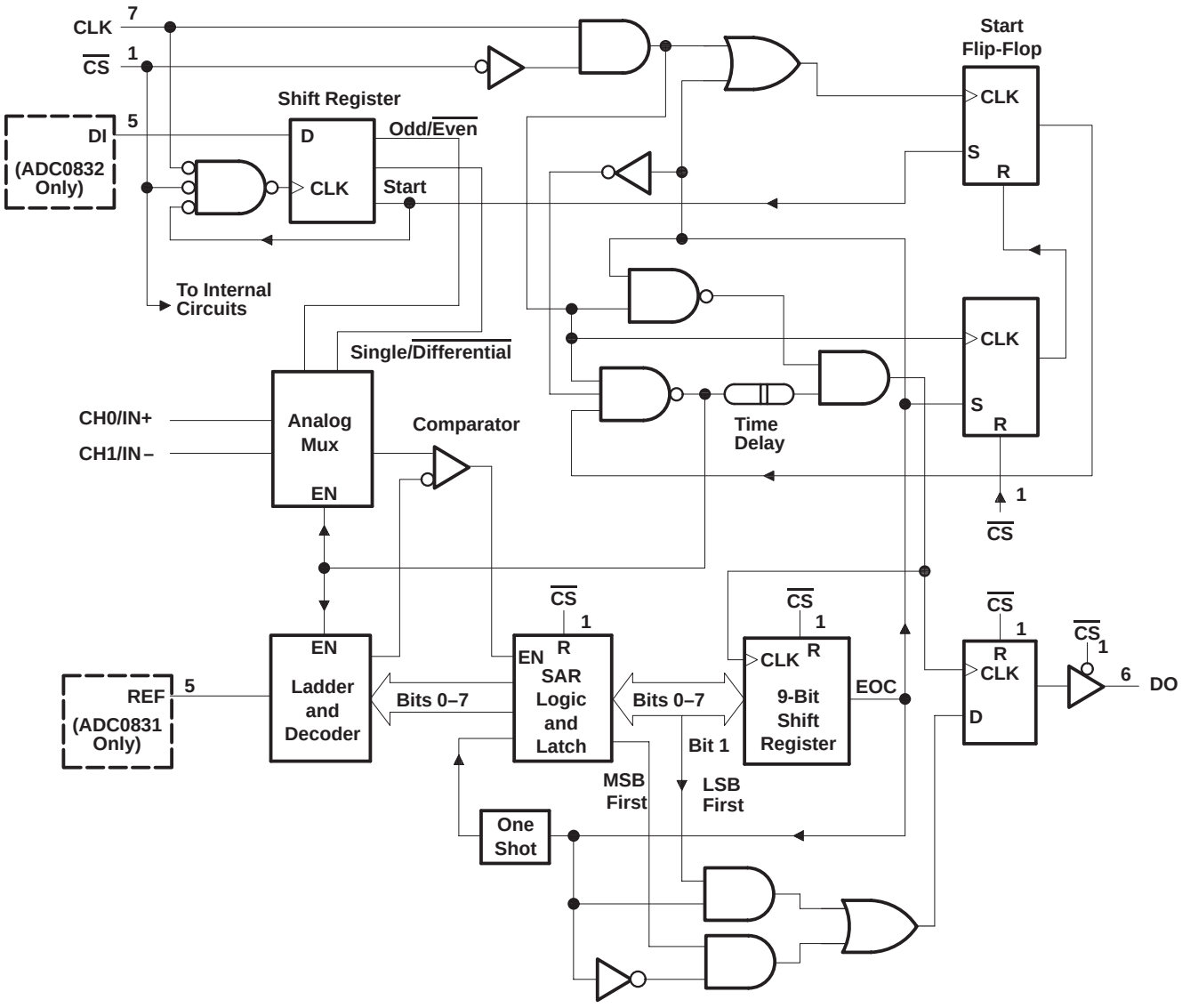
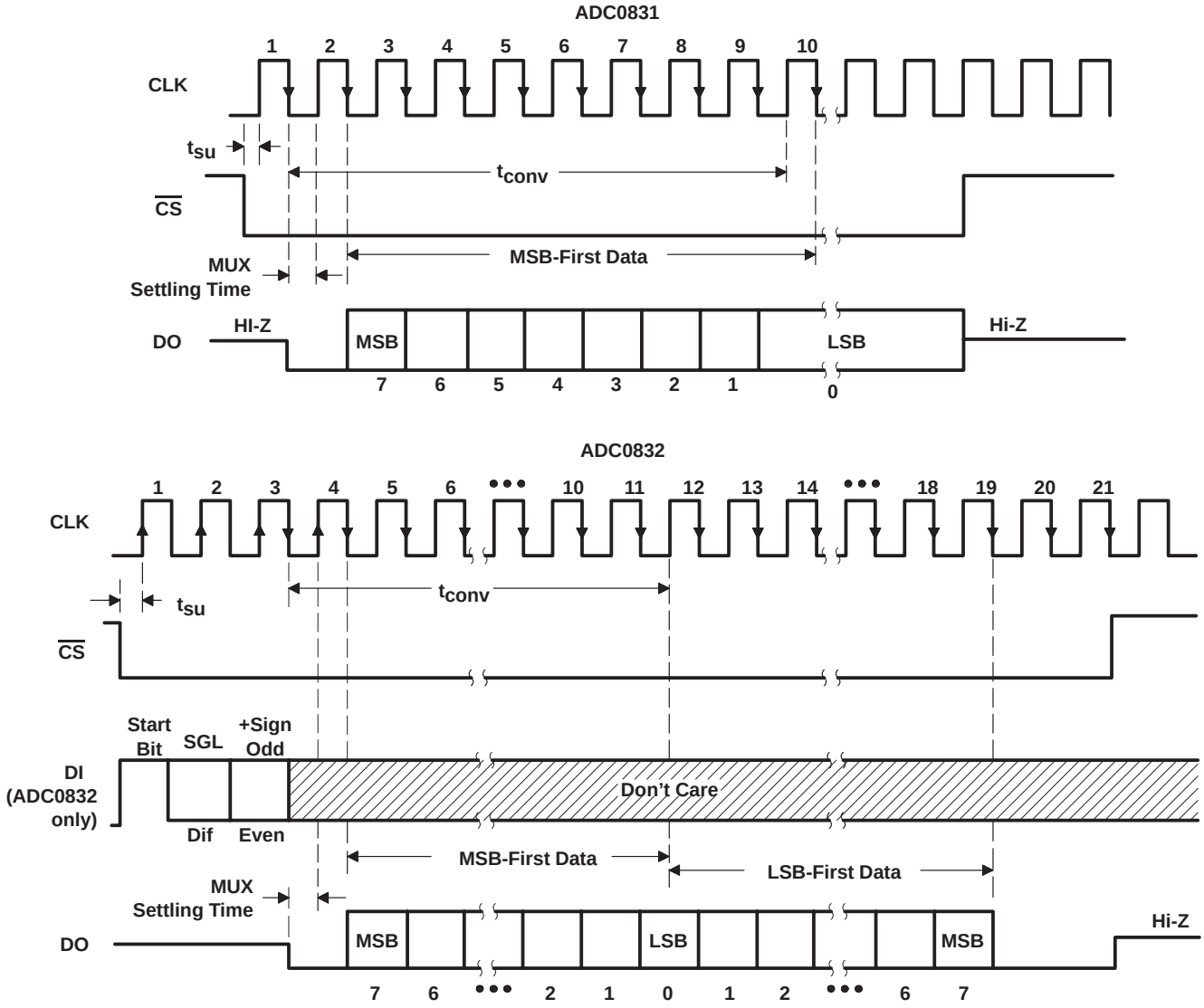
functional block diagram



sequence of operation



ADC0832 MUX ADDRESS CONTROL LOGIC TABLE

MUX ADDRESS		CHANNEL NUMBER	
SGL/$\overline{\text{DIF}}$	ODD/$\overline{\text{EVEN}}$	0	1
L	L	+	–
L	H	–	+
H	L	+	
H	H		+

H = high level, L = low level,
– or + = polarity of selected input pin

absolute maximum ratings over recommended operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 6.5 V
Input voltage range: Logic . . . . . –0.3 V to 15 V
Analog . . . . . –0.3 V to V_{CC} + 0.3
Input current . . . . . ±5 mA
Total input current for package . . . . . ±20 mA
Operating free-air temperature range: C-suffix . . . . . 0°C to 70°C
I-suffix . . . . . –40°C to 85°C
Storage temperature range . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 260°C

NOTE 1: All voltage values, except differential voltages, are with respect to the network ground terminal.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		4.5	5	6.3	V
V_{IH}	High-level input voltage		2			V
V_{IL}	Low-level input voltage				0.8	V
f_{clock}	Clock frequency		10		400	kHz
	Clock duty cycle (see Note 2)		40		60	%
$t_{wH(CS)}$	Pulse duration, $\overline{CS}$ high		220			ns
t_{su}	Setup time, $\overline{CS}$ low or ADC0832 data valid before CLK↑		350			ns
t_h	Hold time, ADC0832 data valid after CLK↑		90			ns
T_A	Operating free-air temperature	C-suffix	0		70	°C
		I-suffix	–40		85	

NOTE 2: The clock duty cycle range ensures proper operation at all clock frequencies. If a clock frequency is used outside the recommended duty cycle range, the minimum pulse duration (high or low) is 1 μs.

electrical characteristics over recommended range of operating free-air temperature, V_{CC} = 5 V, f_{clock} = 250 kHz (unless otherwise noted)

digital section

PARAMETER		TEST CONDITIONS†		C SUFFIX			I SUFFIX			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{OH}	High-level output voltage	V_{CC} = 4.75 V,	I_{OH} = –360 μA	2.8			2.4			V
		V_{CC} = 4.75 V,	I_{OH} = –10 μA	4.6			4.5			
V_{OL}	Low-levl output voltage	V_{CC} = 4.75 V,	I_{OL} = 1.6 mA	0.34			0.4			V
I_{IH}	High-level input current	V_{IH} = 5 V			0.005	1		0.005	1	μA
I_{IL}	Low-level input current	V_{IL} = 0			–0.005	–1		–0.005	–1	μA
I_{OH}	High-level output (source) current	V_{OH} = V_O,	T_A = 25°C	–6.5	–14		–6.5	–14		mA
I_{OL}	Low-level output (sink) current	V_{OL} = V_{CC},	T_A = 25°C	8	16		8	16		mA
I_{OZ}	High-impedance-state output current (DO)	V_O = 5 V,	T_A = 25°C		0.01	3		0.01	3	μA
		V_O = 0,	T_A = 25°C		–0.01	–3		–0.01	–3	
C_i	Input capacitance				5			5		pF
C_o	Output capacitance				5			5		pF

† All parameters are measured under open-loop conditions with zero common-mode input voltage.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

electrical characteristics over recommended range of operating free-air temperature, V_{CC} = 5 V, f_{clock} = 250 kHz (unless otherwise noted)

analog and converter section

PARAMETER			TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{ICR}	Common-mode input voltage range		See Note 3	–0.05 to V_{CC}+0.05			V
$I_{I(stdby)}$	Standby input current (see Note 4)	On-channel	V_I = 5 V			1	µA
		Off-channel	V_I = 0			–1	
		On-channel	V_I = 0			–1	
		Off-channel	V_I = 5 V			1	
$r_{i(REF)}$	Input resistance to reference ladder			1.3	2.4	5.9	kΩ

total device

PARAMETER			TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
I_{CC}	Supply current	ADC0831			1	2.5	mA
		ADC0832			3	5.2	

† All parameters are measured under open-loop conditions with zero common-mode input voltage.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

NOTES: 3. If channel IN– is more positive than channel IN+, the digital output code will be 0000 0000. Connected to each analog input are two on-chip diodes that conduct forward current for analog input voltages one diode drop above V_{CC} .Care must be taken during testing at low V_{CC} levels (4.5 V) because high-level analog input voltage (5 V) can, especially at high temperatures, cause this input diode to conduct and cause errors for analog inputs that are near full-scale. As long as the analog voltage does not exceed the supply voltage by more than 50 mV, the output code will be correct. To achieve an absolute 0 V to 5 V input voltage range requires a minimum V_{CC} of 4.95 V for all variations of temperature and load.

4. Standby input currents are currents going into or out of the on or off channels when the A/D converter is not performing conversion and the clock is in a high or low steady-state condition.

operating characteristics V_{CC} = REF = 5 V, f_{clock} = 250 kHz, $t_r = t_f$ = 20 ns, T_A = 25°C (unless otherwise noted)

PARAMETER			TEST CONDITIONS§	AI, AC SUFFIX			BI, BC SUFFIX			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
	Supply-voltage variation error		V_{CC} = 4.75 V to 5.25 V		±1/16	±1/4		±1/16	±1/4	LSB
	Total unadjusted error (see Note 5)		V_{ref} = 5 V, T_A = MIN to MAX			±1			±1/2	LSB
	Common-mode error		Differential mode		±1/16	±1/4		±1/16	±1/4	LSB
t_{pd}	Propagation delay time, ouput data after CLK↑ (see Note 6)	MSB-first data	C_L = 100 pF		650	1500		650	1500	ns
		LSB-first data			250	600		250	600	
t_{dis}	Output disable time, DO after $\overline{CS}$↑		C_L = 10 pF, R_L = 10 kΩ		125	250		125	250	ns
			C_L = 100 pF, R_L = 2 kΩ			500			500	
t_{conv}	Conversion time (multiplexer addressing time not included)					8			8	clock periods

§ All parameters are measured under open-loop conditions with zero common-mode input voltage. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTES:5. Total unadjusted error includes offset, full-scale, linearity, and multiplexer errors.

6. The most significant-bit-first data is output directly from the comparator and therefore requires additional delay to allow for comparator response time. Least-significant-bit-first data applies only to ADC0832.

PARAMETER MEASUREMENT INFORMATION

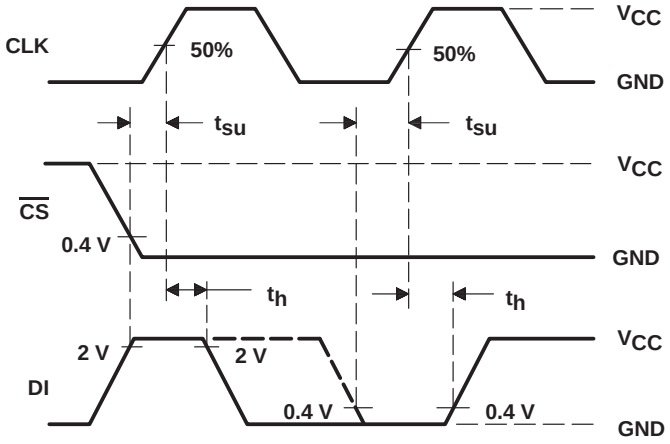


Figure 1. ADC0832 Data Input Timing

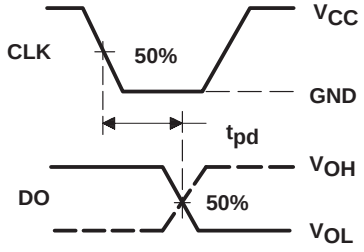
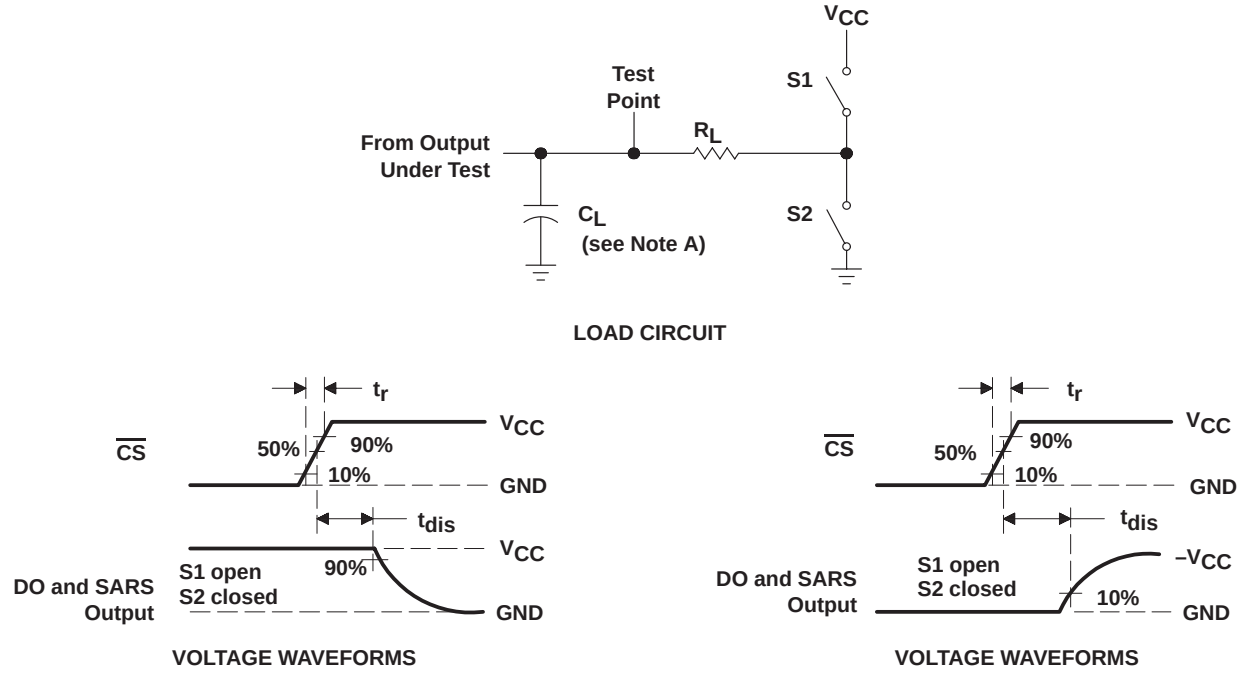


Figure 2. Data Output Timing



NOTE A: C_L includes probe and jig capacitance.

Figure 3. Output Disable Time Test Circuit and Voltage Waveforms

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TYPICAL CHARACTERISTICS

UNADJUSTED OFFSET ERROR vs REFERENCE VOLTAGE

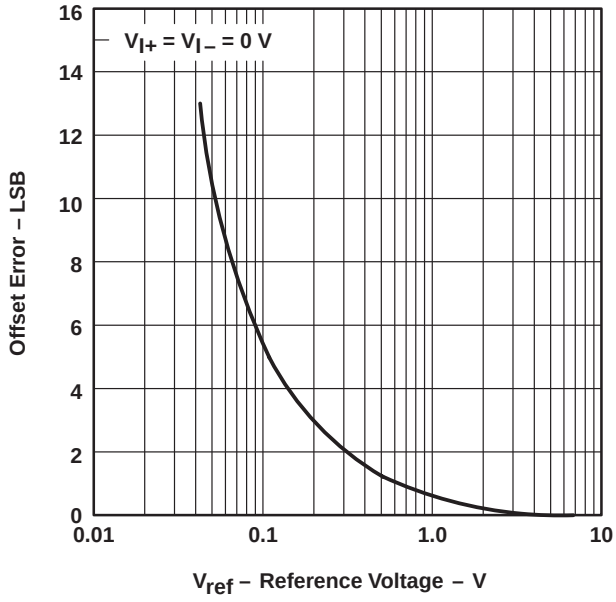

Figure 4

LINEARITY ERROR vs REFERENCE VOLTAGE

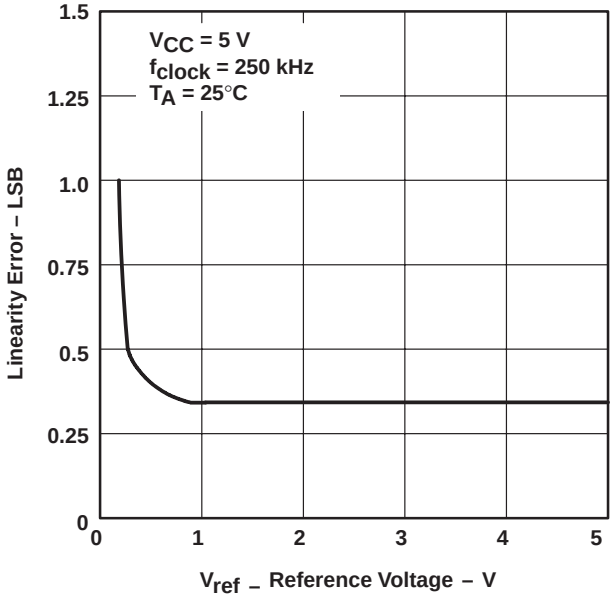

Figure 5

LINEARITY ERROR vs FREE-AIR TEMPERATURE

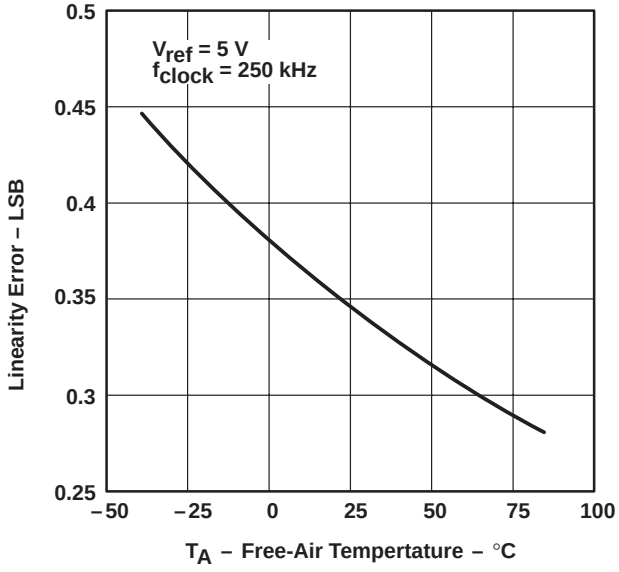

Figure 6

LINEARITY ERROR vs CLOCK FREQUENCY

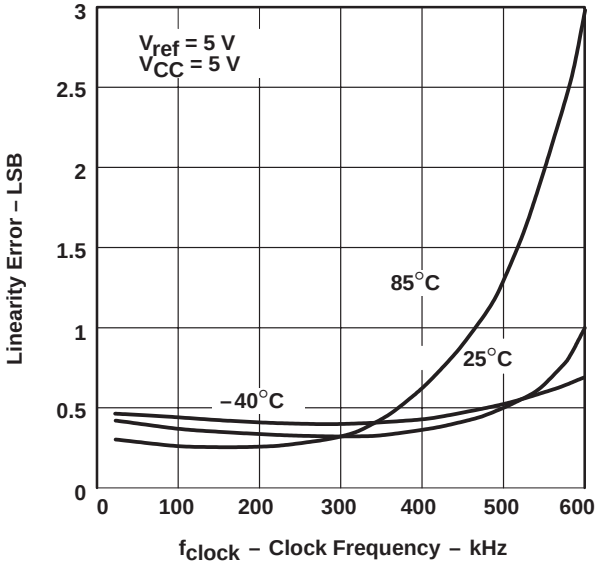

Figure 7

ADC0831
SUPPLY CURRENT
vs
FREE-AIR TEMPERATURE

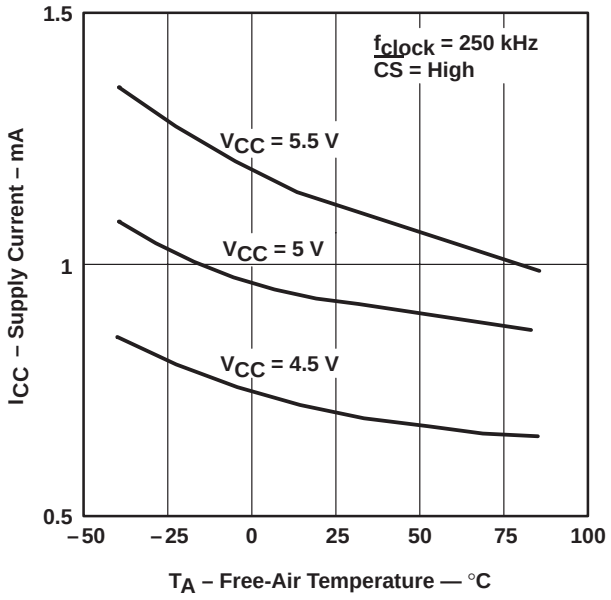

Figure 8

ADC0831
SUPPLY CURRENT
vs
CLOCK FREQUENCY

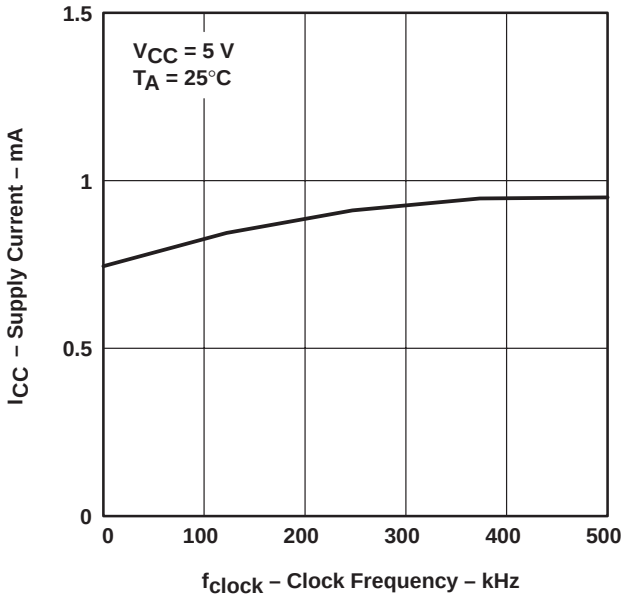

Figure 9

OUTPUT CURRENT
vs
FREE-AIR TEMPERATURE

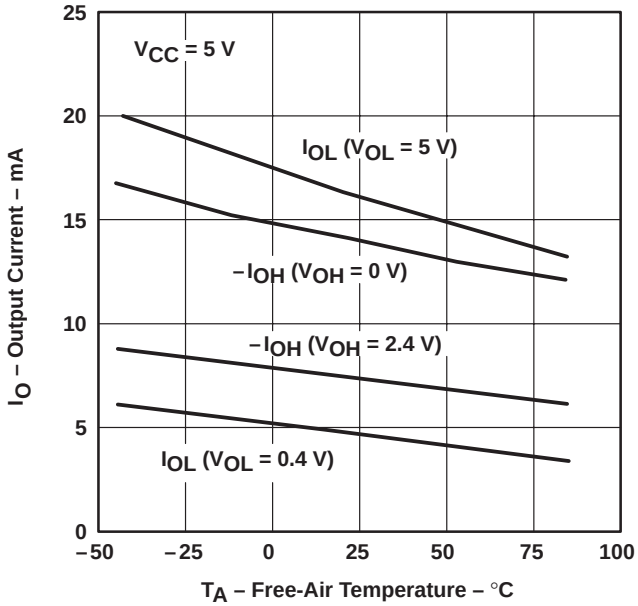

Figure 10

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